

深圳市汉昇实业有限公司

SHENZHEN HANSHENG INDUSTRAIL CO.LTD.,

HS91L02

规格书

DATASHEET

汉昇	制作	审核	批准
以升 HS			

版本: VER 1.0	
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深圳市汉昇实业有限公司

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Revised History

Part Number	Revision	Revision Content	Revised on
=0910		New	2006

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1. Basic Specifications

1.1 Display Specifications

1) Display Mode: Passive Matrix

2) Display Color: Monochrome (White)

3) Drive Duty: 1/32 Duty

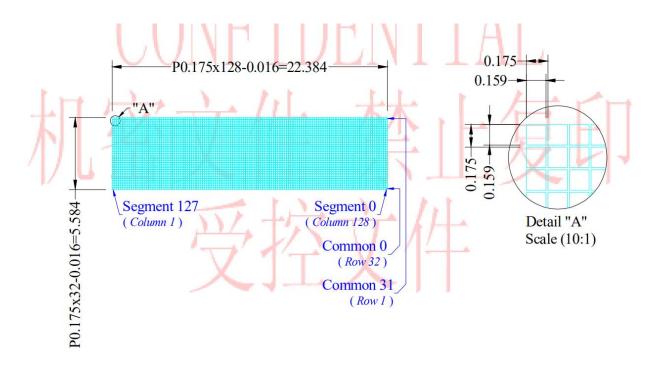
1.2 Mechanical Specifications

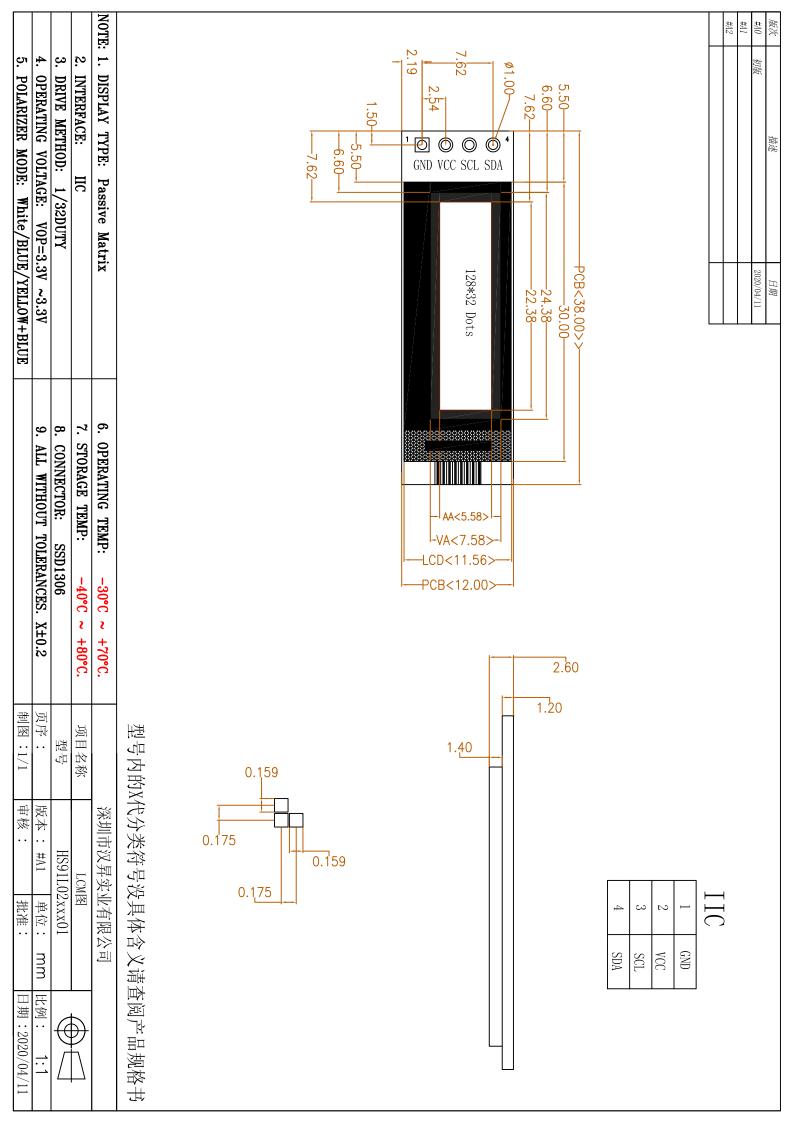
1) Outline Drawing: According to the annexed outline drawing

2) Number of Pixels: 128×32

3) PCB Size: 38×12× 2.6 (mm)
 4) Active Area: 22.384 × 5.584 (mm)
 5) Pixel Pitch: 0.175 × 0.175 (mm)
 6) Pixel Size: 0.159 × 0.159 (mm)

1.3 Active Area / Memory Mapping & Pixel Construction





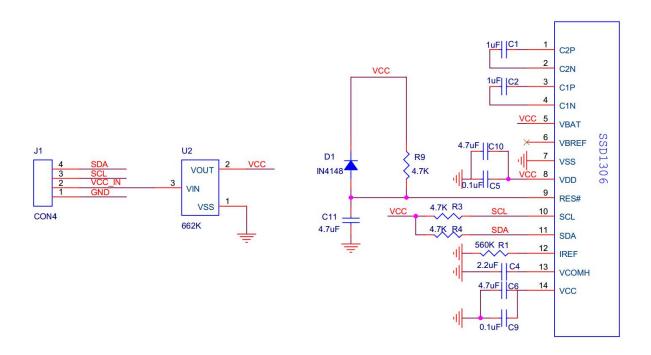
1.5Pin Definition

PIN No.	Symbol	Description
1	GND	Ground of Logic Circuit This is a ground pin. It must be connected to ground
2	VCC	Power Supply for OLED This is a voltage supply pin. It must be connected to source
3	SCL	The serial clock input SCL
4	SDA	The serial data input SDA

1.6 product picture

Top view	Bottom view

1.7 Schematic Diagram



2. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Display	VCC	3	5	V	1, 2
Supply Voltage for Logic	SCL/SDA	1.65	3.3	V	
Operating Temperature	Тор	-40	80	°C	
Storage Temperature	T _{STG}	-40	85	°C	3
Life Time (120 cd/m²)		10,000	-	hour	4
Life Time (80 cd/m²)		30,000	-	hour	4
Life Time (60 cd/m²)		50,000	-	hour	4

- Note 1: All the above voltages are on the basis of "GND = 0V".
- Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.
- Note 3: The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80°C.
- Note 4: VCC = 3.3 V, $T_a = 25^{\circ}\text{C}$, 50% Checkerboard.

Software configuration follows Section 4.4 Initialization.

End of lifetime is specified as 50% of initial brightness reached. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

3.Optics & Electrical Characteristics

3.1 Optics Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Brightness (VCC Supplied Externally)	L _{br}	Note 5	150	-	-	cd/m²
Brightness (VCC Generated by Internal DC/DC)	L _{br}	Note 6	150	180	-	cd/m²
C.I.E.	(x) (y)	C.I.E. 1931	0.12 0.22	0.16 0.26	0.20 0.30	
Dark Room Contrast	CR		-	2000:1	-	
Viewing Angle			-	Free	-	degree

^{*} Optical measurement taken at VDD = 2.8V, VCC = 7.25V. Software configuration follows Section 4.2 Initialization.

3.2DC Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Logic	V_{DD}		1.65	2.8	3.3	V
Supply Voltage for Display (Supplied Externally)	V _{CC}	Note 5 (Internal DC/DC Disable)	6.4	-	9	V
Supply Voltage for DC/DC	V_{BAT}	Internal DC/DC Enable	3.5	-	4.2	V
Supply Voltage for Display (Generated by Internal DC/DC)	V _{CC}	Note 6 (Internal DC/DC Enable)	7.0	7.25	7.5	V
High Level Input	V_{IH}	I _{OUT} = 100μA, 3.3MHz	0.8xV _{DD}	-	V _{DD}	V
Low Level Input	V_{IL}	I _{OUT} = 100μA, 3.3MHz	0	_	0.2xV _{DD}	V
High Level Output	V _{OH}	I _{OUT} = 100μA, 3.3MHz	0.9xV _{DD}	-	V_{DD}	V
Low Level Output	V_{OL}	I _{OUT} = 100μA, 3.3MHz	0	-	0.1xV _{DD}	V
Operating Current for VDD	I _{DD}		-	180	300	uA
Operating Current for VCC (VCC Supplied Externally)	Icc	Note 7	-	10	16	mA
Operating Current for VBAT (VCC Generated by Internal DC/DC)	I _{BAT}	Note 8	-	23	29	mA
Sleep Mode Current for VDD	I _{DD,SLEEP}		_	1	5	uA
Sleep Mode Current for VCC	I _{CC,SLEEP}		-	2	10	uA

Note 5 & 6: Brightness (Lbr) and Supply Voltage for Display (VCC) are subject to the change of the panel characteristics and the customer's request.

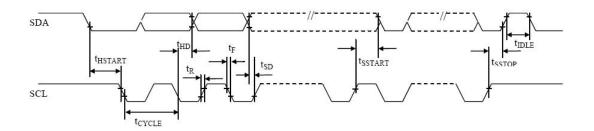
Note 7: VDD = 2.8V, VCC = 7.25V, 100% Display Area Turn on.

Note 8: VDD = 2.8V, VCC = 7.25V, 100% Display Area Turn on.

3.3AC Characteristics

3.3.1 I2C Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t _{cycle}	Clock Cycle Time	2.5	-	μs
t _{HSTART}	Start Condition Hold Time	0.6	-	μs
	Data Hold Time (for "SDA _{OUT} " Pin)	0		
t _{HD}	Data Hold Time (for "SDA _{IN} " Pin)	300	-	ns
t _{SD}	Data Setup Time	100	-	ns
t _{SSTART}	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	μs
t _{SSTOP}	Stop Condition Setup Time	0.6	-	μs
t _R	Rise Time for Data and Clock Pin		300	ns
t _F	Fall Time for Data and Clock Pin		300	ns
t _{IDLE}	Idle Time before a New Transmission can Start	1.3	-	μs



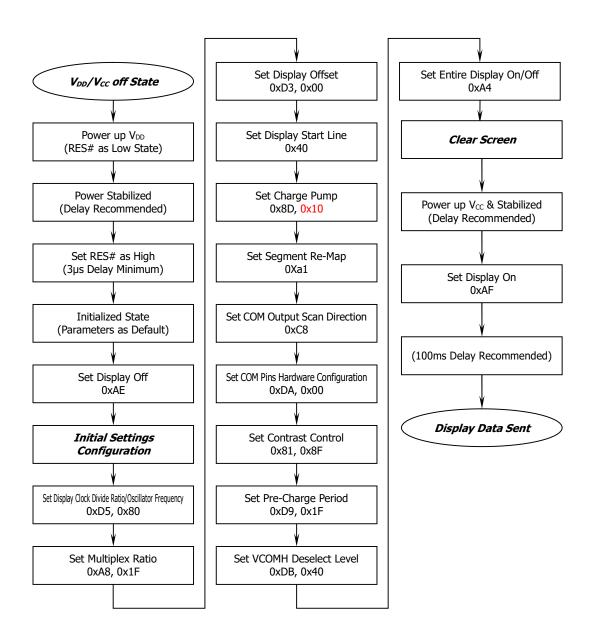
^{*} Software configuration follows Section 4.4 Initialization.

4. Functional Specification

4.1Commands

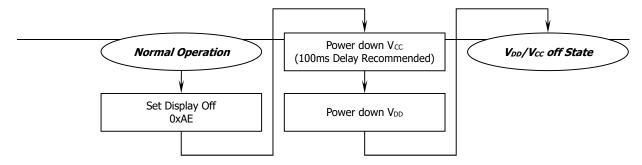
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description		
0	81	1	0	0	0	0	0	0	1	Set Contrast Control	Double byte command to select 1 out of 25		
0	A[7:0]	A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		contrast steps. Contrast increases as the value increases. (RESET = 7Fh)		
0	DB A[7:0	1 0	1 A ₆	0 A ₅	1 A ₄	1 0	0	1 0	1 0	Set V _{COMH} Deselect Level	A[6:4] Hex V COMH deselect level code		
"	A[7.0	"	Α.δ	75	74	"	"	"	"		000b 00h ~ 0.65 x V _{CC}		
]										010b 20h ~ 0.77 x V _{CC} (RESET)		
											011b 30h ~ 0.83 x V _{CC}		
0	A6/A7 AE AF	1	0 0	1 1	0 0	0 1	1	1 1	X ₀	Set Normal/Inverse Display Set Display ON/OFF	A6h, X[0]=0b: Normal display (RESET) 0 in RAM: OFF in display panel 1 in RAM: ON in display panel A7h, X[0]=1b: Inverse display 0 in RAM: ON in display panel 1 in RAM: OFF in display panel AEh, X[0]=0b:Display OFF (sleep mode) (RESET) AFh X[0]=1b:Display ON in normal mode		
0	A0/A1	1	0	1	0	0	0	0	X ₀	Set Segment Re-map	A0h, X[0]=0b: column address 0 is mapped to SEG0 (RESET) A1h, X[0]=1b: column address 127 is mapped to SEG0		
0	C0/C8	1	1	0	0	X ₃	0	0	0	Set COM Output Scan Direction	C0h, X[3]=0b: normal mode (RESET) Scan from COM0 to COM[N -1] C8h, X[3]=1b: remapped mode. Scan from COM[N-1] to COM0 Where N is the Multiplex ratio.		

4.2VCC Generated by Internal DC/DC Circuit

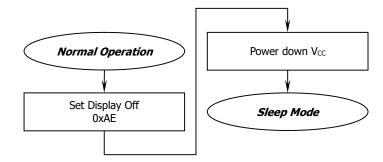


If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

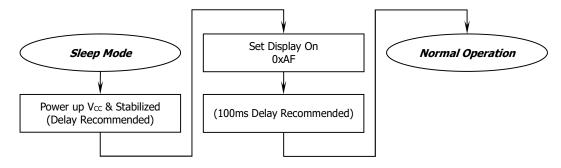
<Power down Sequence>



<Entering Sleep Mode>



<Exiting Sleep Mode>



```
void OLED Init(void)
  //OLED 复位
  OLED RES Clr();//RES 置 0
   delay ms(200);//延时 200ms
   OLED RES Set();//RES 置 1
  //OLED 初始化
   OLED WR Byte(0xAE,OLED CMD); /*display off*/
   OLED_WR_Byte(0x00,OLED_CMD); /*set lower column address*/
   OLED WR Byte(0x10,OLED CMD); /*set higher column address*/
   OLED WR Byte(0x00,OLED CMD); /*set display start line*/
   OLED WR Byte(0xB0,OLED CMD); /*set page address*/
   OLED WR Byte(0x81,OLED CMD); /*contract control*/
   OLED WR Byte(0xff,OLED CMD); /*128*/
   OLED_WR_Byte(0xA1,OLED_CMD); /*set segment remap*/
   OLED WR Byte(0xA6,OLED CMD); /*normal / reverse*/
   OLED WR Byte(0xA8,OLED CMD); /*multiplex ratio*/
   OLED WR Byte(0x1F,OLED CMD); /*duty = 1/32*/
   OLED_WR_Byte(0xC8,OLED_CMD); /*Com scan direction*/
   OLED WR Byte(0xD3,OLED CMD); /*set display offset*/
   OLED WR Byte(0x00,OLED CMD);
   OLED WR Byte(0xD5,OLED CMD); /*set osc division*/
   OLED WR Byte(0x80,OLED CMD);
   OLED WR Byte(0xD9,OLED CMD); /*set pre-charge period*/
   OLED WR Byte(0x1f,OLED CMD);
   OLED WR Byte(0xDA,OLED CMD); /*set COM pins*/
   OLED WR Byte(0x00,OLED CMD);
   OLED WR Byte(0xdb,OLED CMD); /*set vcomh*/
   OLED WR Byte(0x40,OLED CMD);
   OLED WR Byte(0x8d,OLED CMD); /*set charge pump enable*/
   OLED WR Byte(0x14,OLED CMD);
   OLED Clear();
   OLED WR Byte(0xAF,OLED CMD); /*display ON*/
```

}

```
//延时
void IIC_delay(void)
{
   u8 t=1;
   while(t--);
}
//起始信号
void I2C_Start(void)
{
   OLED_SDA_Set();
   OLED_SCL_Set();
   IIC_delay();
   OLED_SDA_Clr();
   IIC_delay();
   OLED_SCL_Clr();
   IIC_delay();
}
//结束信号
void I2C_Stop(void)
{
   OLED_SDA_Clr();
   OLED_SCL_Set();
   IIC_delay();
   OLED_SDA_Set();
}
//等待信号响应
void I2C_WaitAck(void) //测数据信号的电平
{
   OLED_SDA_Set();
   IIC delay();
   OLED_SCL_Set();
   IIC_delay();
   OLED_SCL_Clr();
   IIC_delay();
}
```

```
//写入一个字节
void Send_Byte(u8 dat)
{
   u8 i;
   for(i=0;i<8;i++)
   if(dat&0x80)//将 dat 的 8 位从最高位依次写入
       OLED_SDA_Set();
    }
   else
       OLED_SDA_Clr();
   IIC_delay();
   OLED_SCL_Set();
   IIC_delay();
   OLED_SCL_Clr();//将时钟信号设置为低电平
   dat<<=1;
  }
}
#define OLED_CMD 0 //write command
#define OLED_DATA 1 //write data
//发送一个字节
//mode:数据/命令标志 0,表示命令;1,表示数据;
void OLED_WR_Byte(u8 dat,u8 mode)
{
   I2C_Start();
   Send_Byte(0x78);
   I2C WaitAck();
   if(mode){Send_Byte(0x40);}
  else{Send Byte(0x00);}
   I2C_WaitAck();
   Send_Byte(dat);
   I2C_WaitAck();
   I2C_Stop();
}
```

5. Reliability

5.1 Contents of Reliability Tests

ltem	Conditions	Criteria
High Temperature Operation	70°C, 240 hrs	
Low Temperature Operation	-40°C, 240 hrs	
High Temperature Storage	85°C, 240 hrs	The operational
Low Temperature Storage	-40°C, 240 hrs	functions work.
High Temperature/Humidity Operation	60°C, 90% RH, 120 hrs	
Thermal Shock	-40°C ⇔ 85°C, 24 cycles 60 mins dwell	

^{*} The samples used for the above tests do not include polarizer.

5.2 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at $23\pm5^{\circ}$ C; $55\pm15\%$ RH.

6. Outgoing Quality Control Specifications

6.1 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature: $23 \pm 5 ^{\circ} \text{C}$ Humidity: $55 \pm 15 ^{\circ} \text{RH}$

Fluorescent Lamp: 30W

Distance between the Panel & Lamp: ≥ 50cm

Distance between the Panel & Eyes of the Inspector: ≥ 30cm

Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic.

^{*} No moisture condensation is observed during tests.

6.2Sampling Plan

Level II, Normal Inspection, Single Sampling, MIL-STD-105E

6.3 Criteria & Acceptable Quality Level

Partition	AQL	Definition	
Major	0.65	Defects in Pattern Check (Display On)	
Minor	1.0	Defects in Cosmetic Check (Display Off)	

6.3.1 Cosmetic Check (Display Off) in Non-Active Area

Check Item	Classification	Criteria
Panel General Chipping	Minor	X > 6 mm (Along with Edge) Y > 1 mm (Perpendicular to edge)

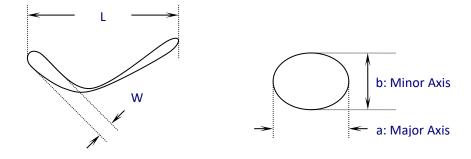
6.3.2 Cosmetic Check (Display Off) in Active Area

It is recommended to execute in clear room environment (class 10k) if actual in necessary.

Check Item	Classification	Criteria	
Any Dirt & Scratch on Polarizer's	Acceptable	Ignore for not Affect the Polarizer	
Protective Film	Acceptable		

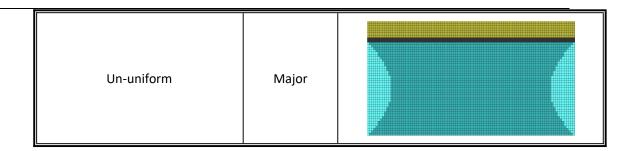
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	W ≤ 0.1 W > 0.1 L ≤ 2 L > 2	lgnore n ≤ 1 n = 0
Dirt, Black Spot, Foreign Material, (On Polarizer)	Minor	Φ ≤ 0.1 0.1 < Φ ≤ 0.25 0.25 < Φ	lgnore n ≤ 1 n = 0
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	Φ ≤ 0.5 → Ignore if no Infl 0.5 < Φ	luence on Display n = 0
Fingerprint, Flow Mark (On Polarizer)	Minor	Not Al	lowable

- * Protective film should not be tear off when cosmetic check.
- ** Definition of W & L & Φ (Unit: mm): Φ = (a + b) / 2



6.3.3 Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	



7. Precautions When Using These OEL Display Modules

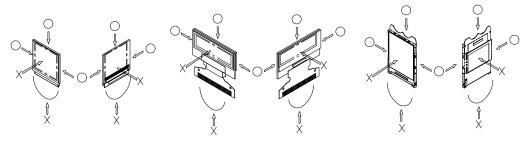
7.1 Handling Precautions

- Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- 6) Hold OEL display module very carefully when placing OEL display module into the system housing. Do not apply excessive stress or pressure to OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the driver IC and the surrounding molded sections.
- 8) Do not disassemble nor modify the OEL display module.

- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OEL display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.
 - * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - * Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

7.2Storage Precautions

1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0 ° C) environments. (We recommend you to store these modules in the packaged state when they were shipped from 0 = @ Co.,Ltd.)

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

7.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the V_{IL} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible.
- We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (V_{DD}) . (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OEL display module, fasten the external plastic housing section.

- 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1306
- * Connection (contact) to any other potential than the above may lead to rupture of the IC.

7.4 Precautions when disposing of the OEL display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

7.5Other Precautions

- When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
 Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- 2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.
 - * Pins and electrodes
 - * Pattern layouts such as the FPC
- 3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OEL driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.
 - 4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
 - 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

Warranty:

The warranty period shall last twelve (12) months from the date of delivery. Buyer shall be completed to assemble all the processes within the effective twelve (12) months.o = Industrail Co.,Ltd. shall be liable for replacing any products which contain defective material or process which do not conform to the product specification, applicable drawings and specifications during the warranty period. All products must be preserved, handled and appearance to permit efficient handling during warranty period. The warranty coverage would be exclusive while the returned goods are out of the terms above.

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